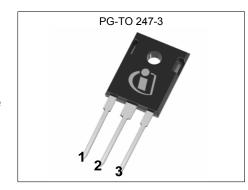


MOSFET

600V CoolMOS™ P7 Power Transistor

The CoolMOS™ 7th generation platform is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The 600V CoolMOS™ P7 series is the successor to the CoolMOS™ P6 series. It combines the benefits of a fast switching SJ MOSFET with excellent ease of use, e.g. very low ringing tendency, outstanding robustness of body diode against hard commutation and excellent ESD capability. Furthermore, extremely low switching and conduction losses make switching applications even more efficient, more compact and much cooler.



Features

- Suitable for hard and soft switching (PFC and LLC) due to an outstanding commutation ruggedness
- Significant reduction of switching and conduction losses
- Excellent ESD robustness >2kV (HBM) for all products
- Better R_{DS(on)}/package products compared to competition enabled by a low R_{DS(on)}*A (below 10hm*mm²)
- Fully qualified acc. JEDEC for Industrial Applications



- Ease of use and fast design-in through low ringing tendency and usage across PFC and PWM stages
- Simplified thermal management due to low switching and conduction losses
- Increased power density solutions enabled by using products with smaller footprint and higher manufacturing quality due to >2 kV ESD protection
- Suitable for a wide variety of applications and power ranges

Potential applications

PFC stages, hard switching PWM stages and resonant switching stages for e.g. PC Silverbox, Adapter, LCD & PDP TV, Lighting, Server, Telecom and UPS.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



1 4.0.0				
Parameter	Value	Unit		
V _{DS} @ T _{j,max}	650	V		
R _{DS(on),max}	99	mΩ		
$Q_{g,typ}$	45	nC		
I _{D,pulse}	100	A		
E _{oss} @ 400V	5.0	μЈ		
Body diode di _F /dt	900	A/µs		

Type / Ordering Code	Package	Marking	Related Links
IPW60R099P7	PG-TO 247-3	60R099P7	see Appendix A

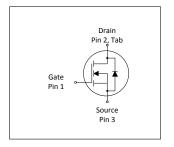












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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	Ob. a.l		Value	s	11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	31 20	A	T _C =25°C T _C =100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	100	Α	T _C =25°C
Avalanche energy, single pulse	E _{AS}	-	-	105	mJ	I _D =5.1A; V _{DD} =50V; see table 10
Avalanche energy, repetitive	E AR	-	-	0.53	mJ	I _D =5.1A; V _{DD} =50V; see table 10
Avalanche current, single pulse	I _{AS}	-	-	5.1	Α	-
MOSFET dv/dt ruggedness	dv/dt	-	-	80	V/ns	V _{DS} =0400V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	117	W	<i>T</i> _C =25°C
Storage temperature	T _{stg}	-55	-	150	°C	-
Operating junction temperature	T _j	-55	-	150	°C	-
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws
Continuous diode forward current	Is	-	-	31	Α	<i>T</i> _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	100	Α	<i>T</i> _C =25°C
Reverse diode dv/dt ³⁾	dv/dt	-	-	50	V/ns	V_{DS} =0400V, I_{SD} <=31A, T_{j} =25°C see table 8
Maximum diode commutation speed	di _F /dt	-	-	900	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=31A, $T_{\rm j}$ =25°C see table 8
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min

 $^{^{1)}}$ Limited by $T_{j,max}.$ Maximum Duty Cycle D = 0.50 $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

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2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			11	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	1.07	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	-
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

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3 Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 Static characteristics

Parameter	Ol		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V _{GS} =0V, I _D =1mA
Gate threshold voltage	$V_{(GS)th}$	3	3.5	4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.53{\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 10	1 -	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.077 0.180	0.099	Ω	V _{GS} =10V, I _D =10.5A, T _j =25°C V _{GS} =10V, I _D =10.5A, T _j =150°C
Gate resistance	R _G	-	5.9	-	Ω	f=1MHz, open drain

Table 5 Dynamic characteristics

Danamatan	Or made al		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	1952	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Output capacitance	Coss	-	33	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	62	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	649	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V
Turn-on delay time	t _{d(on)}	-	23	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =10.5A, $R_{\rm G}$ =5.3 Ω ; see table 9
Rise time	t _r	-	15	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =10.5A, $R_{\rm G}$ =5.3Ω; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	89	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =10.5A, $R_{\rm G}$ =5.3Ω; see table 9
Fall time t _f		-	5	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =10.5A, $R_{\rm G}$ =5.3Ω; see table 9

 Table 6
 Gate charge characteristics

Parameter	Cymbal	Values			11	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	11	-	nC	V_{DD} =400V, I_{D} =10.5A, V_{GS} =0 to 10V
Gate to drain charge	Q_{gd}	-	13	-	nC	V_{DD} =400V, I_{D} =10.5A, V_{GS} =0 to 10V
Gate charge total	Q_g	-	45	-	nC	V_{DD} =400V, I_{D} =10.5A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.2	-	V	V_{DD} =400V, I_{D} =10.5A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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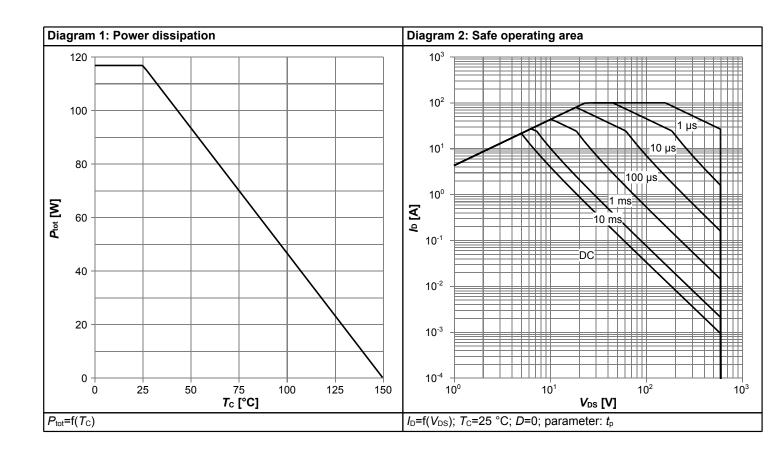


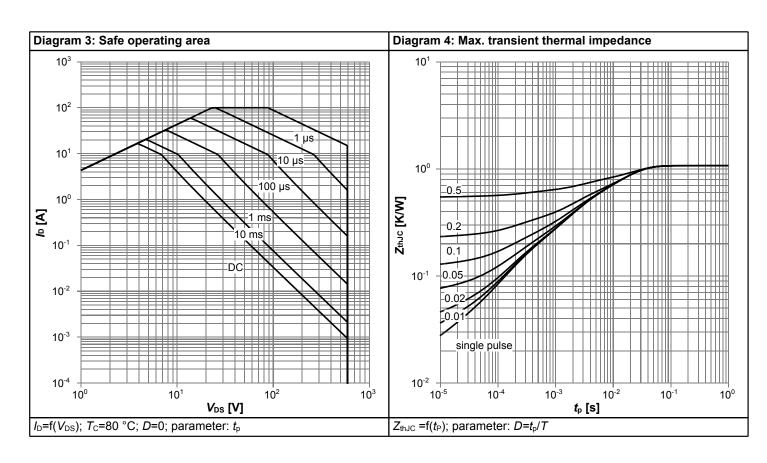
Table 7 Reverse diode characteristics

Parameter	Cumbal	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V_{GS} =0V, I_{F} =10.5A, T_{j} =25°C
Reverse recovery time	t _{rr}	-	211	-	ns	V_R =400V, I_F =4A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	2.1	-	μC	V_R =400V, I_F =4A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	20.1	-	А	V_R =400V, I_F =4A, di_F/dt =100A/ μ s; see table 8

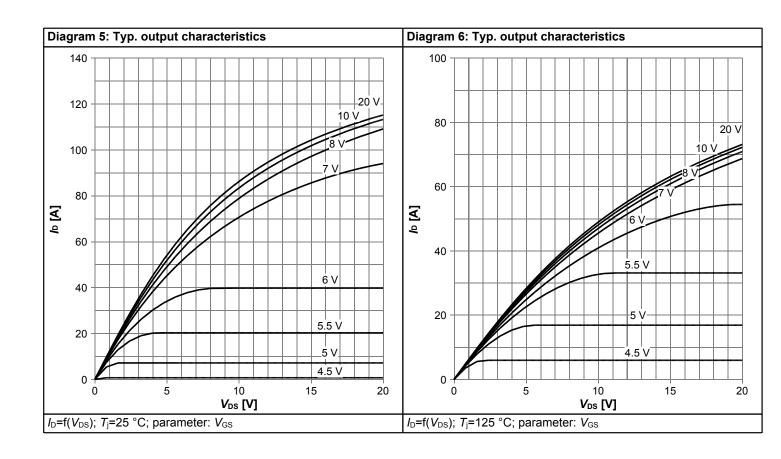


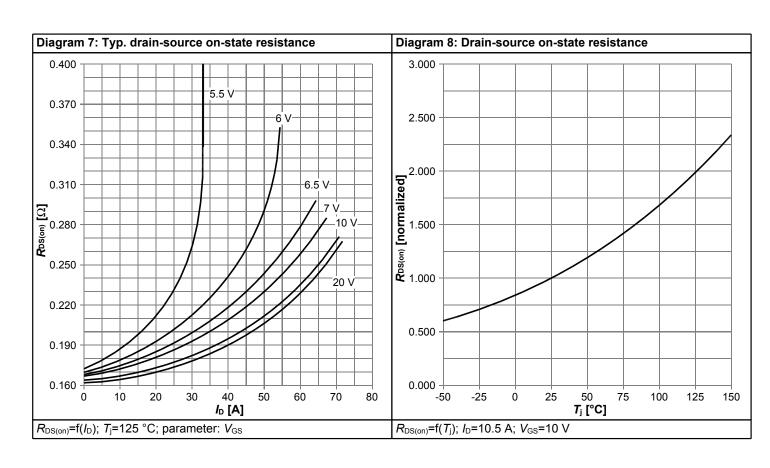
4 Electrical characteristics diagrams



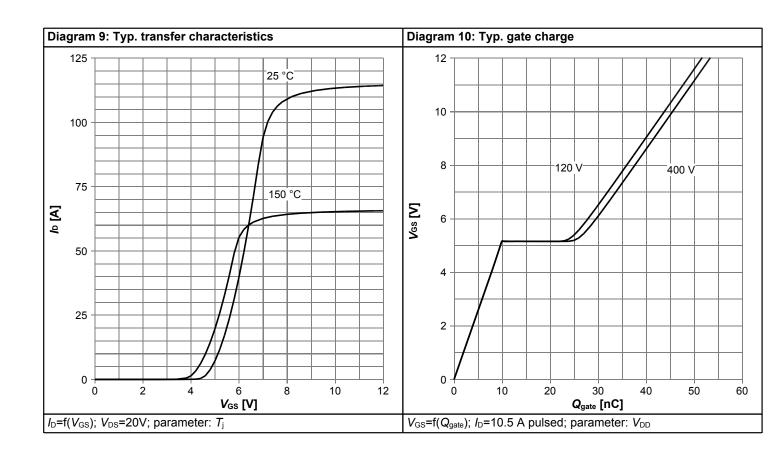


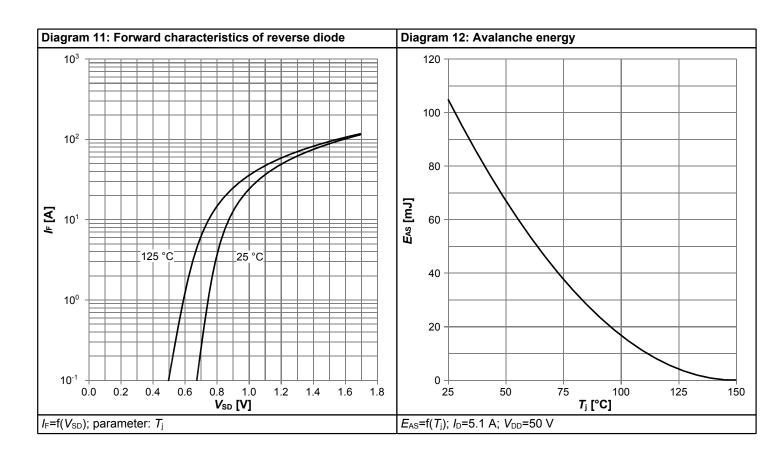




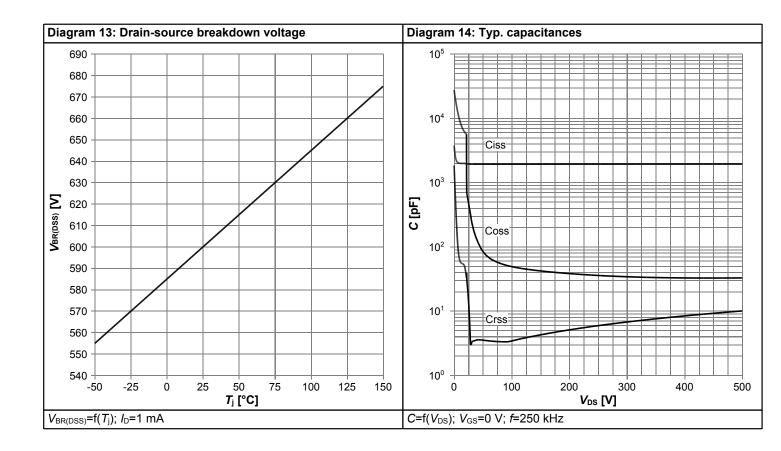


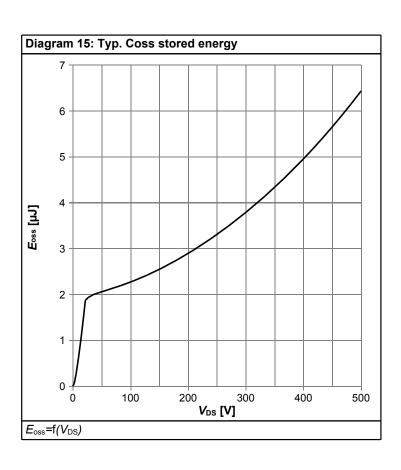
















5 Test Circuits

Table 8 Diode characteristics

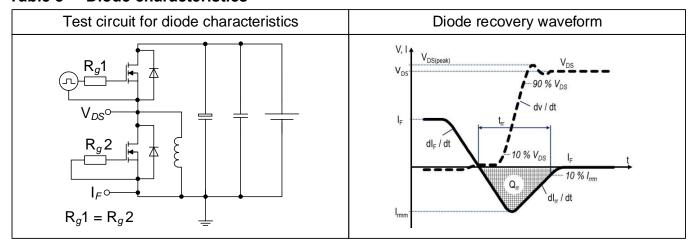
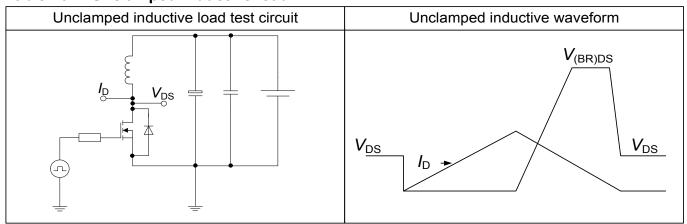


Table 9 Switching times



Table 10 Unclamped inductive load





6 Package Outlines

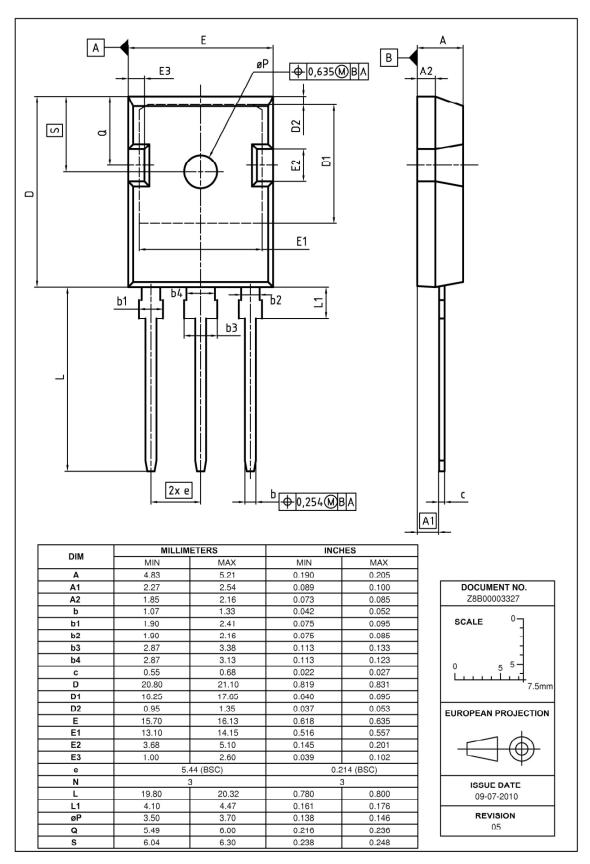


Figure 1 Outline PG-TO 247-3, dimensions in mm/inches

600V CoolMOS™ P7 Power Transistor IPW60R099P7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS P7 Webpage: www.infineon.com

• IFX CoolMOS P7 application note: www.infineon.com

• IFX CoolMOS P7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPW60R099P7



Revision History

IPW60R099P7

Revision: 2018-05-15, Rev. 2.1

Previous Revision

Trevious Nevision							
Revision	Date Subjects (major changes since last revision)						
2.0	2017-05-18	Release of final version					
2.1	2018-05-15	Updated diagram scalings; Nomenclature of product qualification grade was changed					

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Final Data Sheet 14 Rev. 2.1, 2018-05-15